

MODEL NO. : _	TM028HBH26
ISSUED DATE:	2010-9-30
VERSION :_	Ver 1.0

■ Preliminary Specification

□ Final Product Specification

Customer	•
Custoniei	•

Approved by	Notes
\ \(\frac{1}{2}\)	

## **SHANGHAI TIANMA Confirmed:**

Prepared by	Checked by	Approved by

This technical specification is subjected to change without notice

# **Table of Contents**

Tab	le of Contents	 2
1.	General Specifications	 4
2.	Input/Output Terminals	 5
3.	Absolute Maximum Ratings	 7
4.	Electrical Characteristics	8
5.	Timing Chart	10
6.	Optical Characteristics	18
	Mechanical Drawing	
	Environmental / Reliability Tests	
	Precautions for Use of LCD Modules	



# **Record of Revision**

Rev	Issued Date	Description	Editor
1.0	2010-9-30	First release	Kelly hu
	_		
	4		

# 1. General Specifications

	Fe	eature	Spec	
	Size		2.8"	
	Resolution	1	240(RGB)x320	
	Interface		CPU 8/16bit	
	Color Dep	th	262k	
	Technolog	y type	a-si TFT	
Display Spec.	Pixel pitch	(mm)	0.180x0.180	
	Display colors		262K	
	Pixel Configuration		RGB vertical Stripe	
	Display M	ode	TM,NW	
	Surface Tr	reatment	clear type	
	Gray Scal	e inversion direction	12 o'clock	
	DIM.	Pixel (H x V) (mm)	0.180x0.180	
	DIIVI.	LCM (W x H x D) (mm)	50.00x69.20x4.2	
Mechanical	Active Are	a(mm)	43.2x57.6	
Characteristics	With /With	out TSP	WITH TSP	
	Weight (g)		TBD.	
	Driver IC		ILI9335	
	LED Num	bers	4 LEDs ( parallel)	

Note 1: Viewing direction for best image quality is different from TFT definition. There is a 180 degree shift.

Note 2: Requirements on Environmental Protection: Q/S0002

Note 3: LCM weight tolerance: ± 5%



# 2. Input/Output Terminals

No	Symbol	I/O	Description	Comment
1	D0	I/O	Data input	
2	D1	I/O	Data input	
3	D2	I/O	Data input	
4	D3	I/O	Data input	
5	GND	Р	Ground	
6	VCC	Р	Power Supply	
7	CS	1	A chip select signal	
8	RS	1	A register select signal	
9	WR	I	A write strobe signal and actives when the signal is low	
10	RD	I	A read strobe signal and actives when the signal is low	
11	IM0	I	Mode selection	Note1
12	XR	0	Touch panel pin	
13	YD	0	Touch panel pin	
14	XL	0	Touch panel pin	
15	YU	0	Touch panel pin	
16	LED-A	Р	LED anode	
17	LED-K1	Р	LED cathode	
18	LED-K2	Р	LED cathode	
19	LED-K3	P	LED cathode	
20	LED-K4	P	LED cathode	
21	IM2	T	Mode Selection(connect to GND)	
22	D4	I/O	Data input	
23	D8	I/O	Data input	
24	D9	I/O	Data input	
25	D10	I/O	Data input	
26	D11	I/O	Data input	
27	D12	I/O	Data input	
28	D13	I/O	Data input	
29	D14	I/O	Data input	
30	D15	I/O	Data input	
31	RESET	I	A RESET signal	
32	VCI	Р	Analog power supply	

The information contained herein is the exclusive property of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation.



# **SHANGHAI TIANMA MICRO-ELECTRONICS**

## TM028HBH26 V1.0

33	VCC	Р	_ogic power supply	
34	GND	Р	Ground	
35	D5	I/O	Data input	
36	D6	I/O	Data input	
37	D7	I/O	Data input	

## Note1:

IM0	MCU Interface Mode Data bus		
0	16bit	DB[15:0]	
1	8bit	DB[15:8]	

Table 2.1 input terminal pin assignment

Page: 6 of 26

# 3. Absolute Maximum Ratings

Ta = 25℃

Item	Symbol	MIN	MAX	Unit	Remark
Logic Supply Voltage	VCC	-0.3	4.6	<b>V</b>	
Analog Supply Voltage	VCI	-0.3	4.6	V	
Input voltage	D0~D15,CS,RS,WR,RD RESET,FMARK,IM0	-0.3	VCC+0.3	V	
Back Light Forward Current	I <sub>LED</sub>		25	mA	For each LED
Touch panel operating voltage	X+,Y+,X-,Y-		7	V	
Operating Temperature	$T_OPR$	-20	60	$^{\circ}$	
Storage Temperature	T <sub>STG</sub>	-30	70	°C	

Table 3.1 absolute maximum rating

Page: 7 of 26

# 4. Electrical Characteristics

#### 4.1 LCD module

GND=0V,Ta=25°C

Item		Symbol	MIN	TYP	MAX	Unit	Remark
Logic Supply Voltage		VCC	1.6	1.8/2.8	3.6	>	
Analog Sup	ply Voltage	VCI	2.5	2.8	3.6	V	<b>A</b>
Input Signal	Low Level	$V_{IL}$	-0.3		0.2xVCC	٧	
Voltage	High Level	V <sub>IH</sub>	0.8xVCC		VCC	V	
(Panel+LSI)		Black Mode (60Hz)	-	-	-	mW	
Power Consu	umption	8 color Mode		-		mW	
		Sleeping Mode		-		mW	

Table 4.1 LCD module electrical characteristics

## 4.2 Backlight Unit

Ta=25°C

Item	Symbol	MIN	TYP	MAX	Unit	Remark
Forward Current	I <sub>F</sub>		20	25	mA	For One LED
Forward Current Voltage	V <sub>F</sub>		3.2		V	
Backlight Power Consumption	W <sub>BL</sub>		256		mW	

Table 4.2.1 backlight unit electrical characteristics

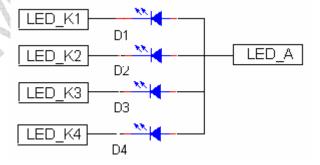


Figure 4.2.2 LED driver circuit

#### 4.3 BLOCK DIAGRAM

## LCD module diagram

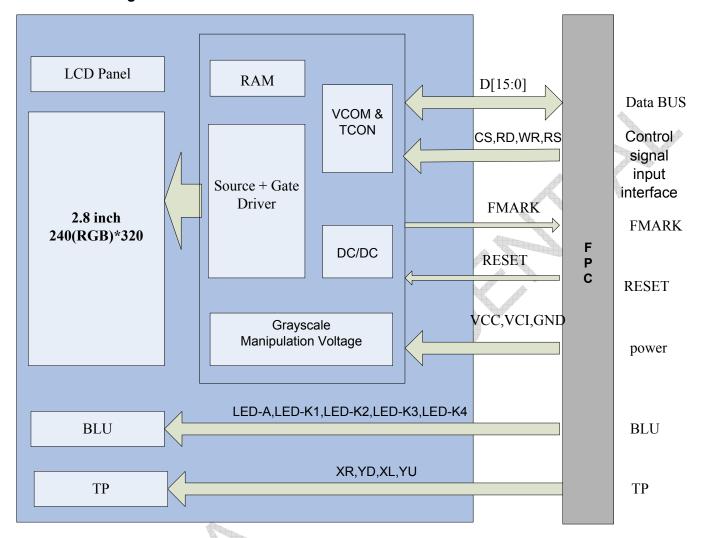


Figure 4.3 LCD module diagram

# 5. Timing Chart

# 5.1 Interface Timing Parameters

## **Normal Write Mode**

Item	Symbol	Unit	Min	Тур	Max
Write bus cycle time	t <sub>CYCW</sub>	ns	(75)	-	-
Write low-level pulse width	PW <sub>LW</sub>	ns	(40)	-	-
Write high-level pulse width	PW <sub>HW</sub>	ns	(30)	-	-
Write rise / fall time	t <sub>Wr</sub> / t <sub>Wf</sub>	ns	-	-	25
Write Setup time ( RS to /CS, /WR )	t <sub>AS</sub>	ns	10	-	-
Address hold time	t <sub>AH</sub>	ns	5	-	-
Write data set up time	t <sub>DSW</sub>	ns	10	4	-
Write data hold time	t <sub>H</sub>	ns	15		-

Table 5.1 timing parameter

## 5.2 Interface Characteristics

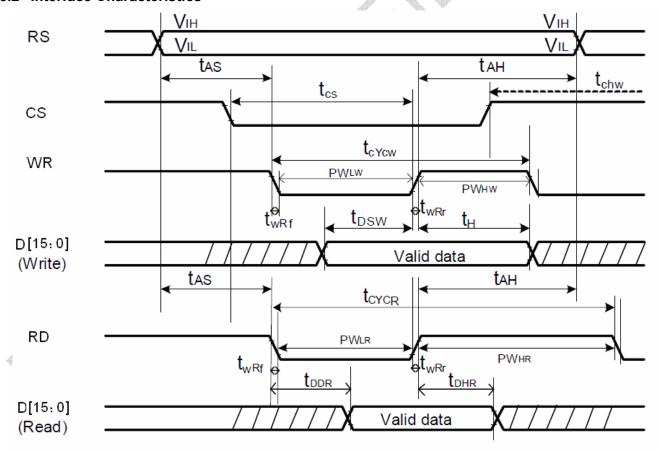


Figure 5.2 CPU Interface Characteristics

The information contained herein is the exclusive property of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation.

Page: 10 of 26

#### 5.3 Interface Register write/read timing

#### 5.3.1 System Bus Interface Register Write Timing

#### a) i80 8-bit System Bus Interface Timing

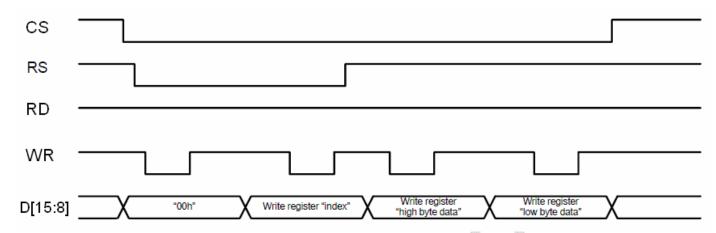


Figure 5.3.1.1 i80 8-bit System Bus Interface Timing



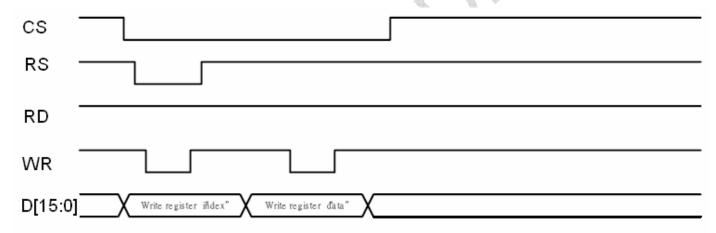


Figure 5.3.1.2 i80 16-bit System Bus Interface Timing

# 5.3.2 System Bus Interface Register Read Timing

#### a) i80 8-bit System Bus Interface Timing

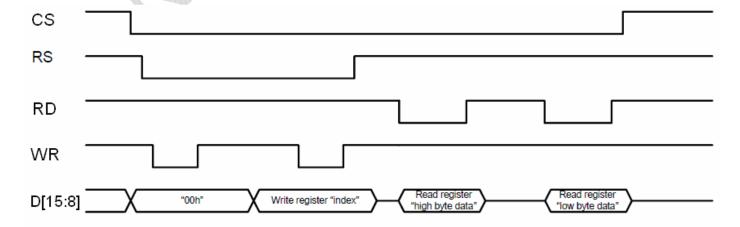


Figure 5.3.2.1 i80 8-bit System Bus Interface Timing

The information contained herein is the exclusive property of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation.

Page: 11 of 26

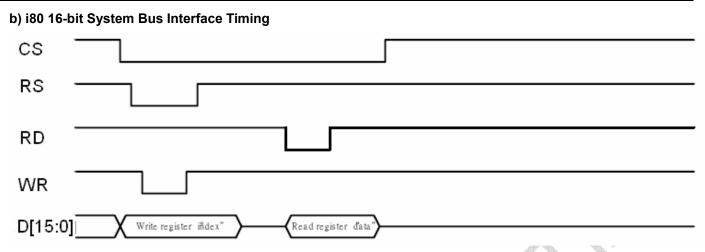


Figure 5.3.2.2 i80 16-bit System Bus Interface Timing

## 5.4 8-bit System interface Data Format

a) i80-System Interface with 8-bit Data Bus

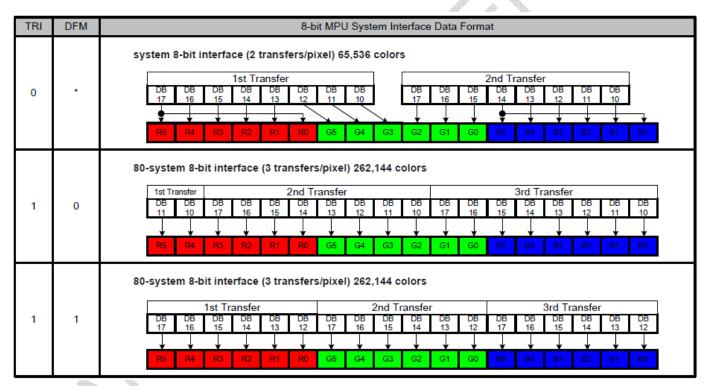


Figure 5.4.1 i80-System Interface with 8-bit Data Bus

The information contained herein is the exclusive property of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation.

Page: 12 of 26

#### b) i80-System Interface with 16-bit Data Bus



Figure 5.4.2 i80-System Interface with 8-bit Data Bus

# 5.5 Data Bus GRAM Write/Read Timing

#### 5.5.1 GRAM Write Timing

a) GRAM Write Timing of i80 8-bit System Interface

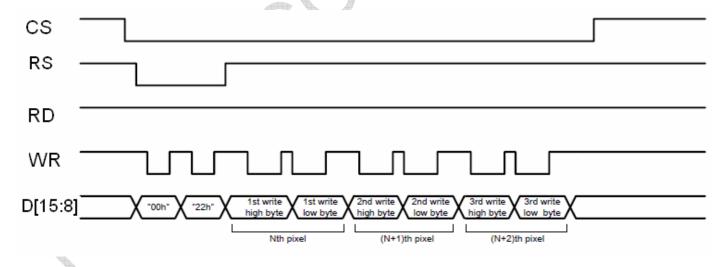


Figure 5.5.1.1 GRAM Write Timing of i80 8-bit System Interface

The information contained herein is the exclusive property of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation.

Page: 13 of 26

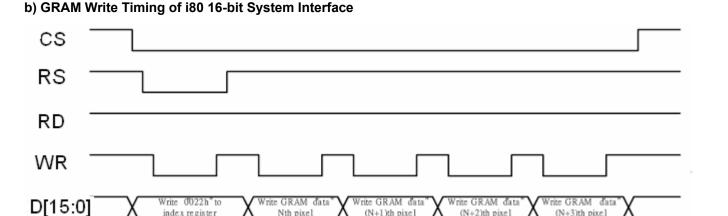


Figure 5.5.1.2 GRAM Write Timing of i80 16-bit System Interface

## 5.5.2 GRAM Read Timing

a) GRAM Read Timing of i80 8-bit System Interface

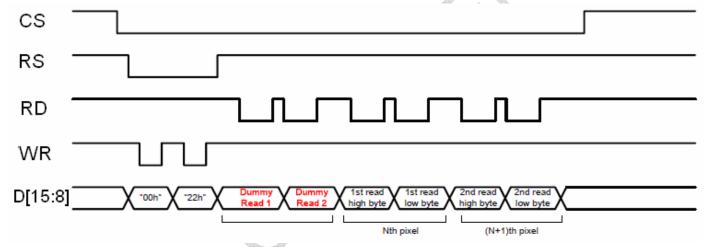


Figure 5.5.2.1 GRAM Read Timing of i80 8-bit System Interface

b) GRAM Read Timing of i80 16-bit System Interface

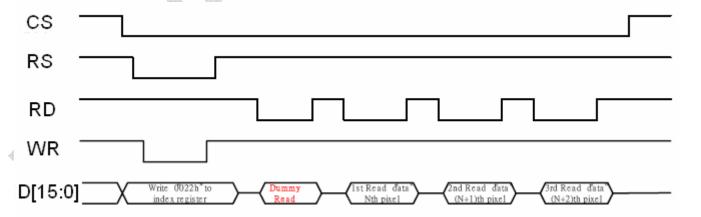


Figure 5.5.2.2 GRAM Read Timing of i80 16-bit System Interface

The information contained herein is the exclusive property of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation.

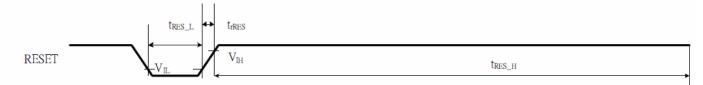
Page: 14 of 26



#### **Reset Timing Characteristics**

Reset Timing Characteristics (VCC = 1.6 ~ 3.6 V)

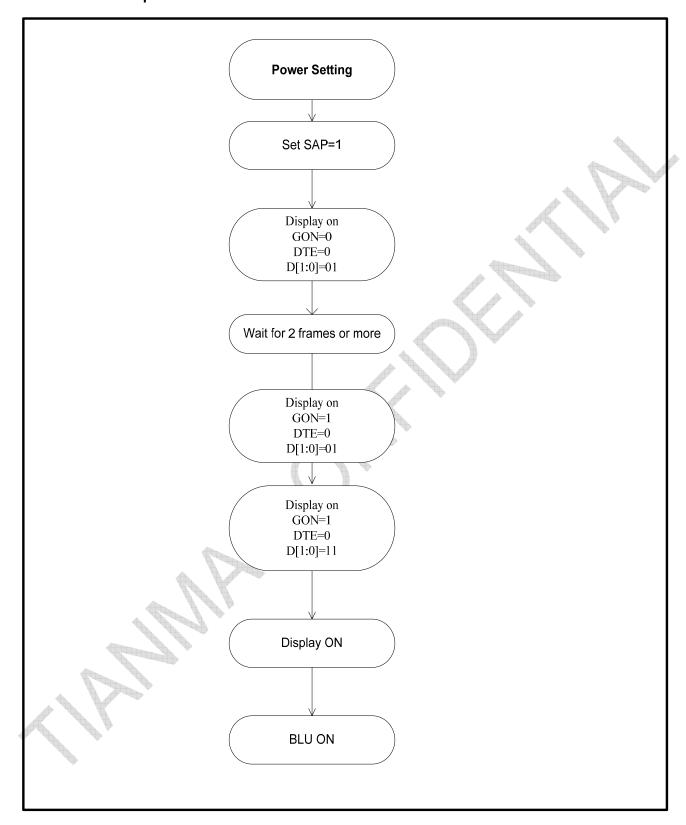
Item	Symbol	Unit	Min.	Тур.	Max.
Reset low-level width	t <sub>RES L</sub>	ms	1	-	-
Reset rise time	t <sub>rRES</sub>	μs	-	-	10
Reset high-level width	t <sub>RES H</sub>	ms	50	-	-



Page: 15 of 26



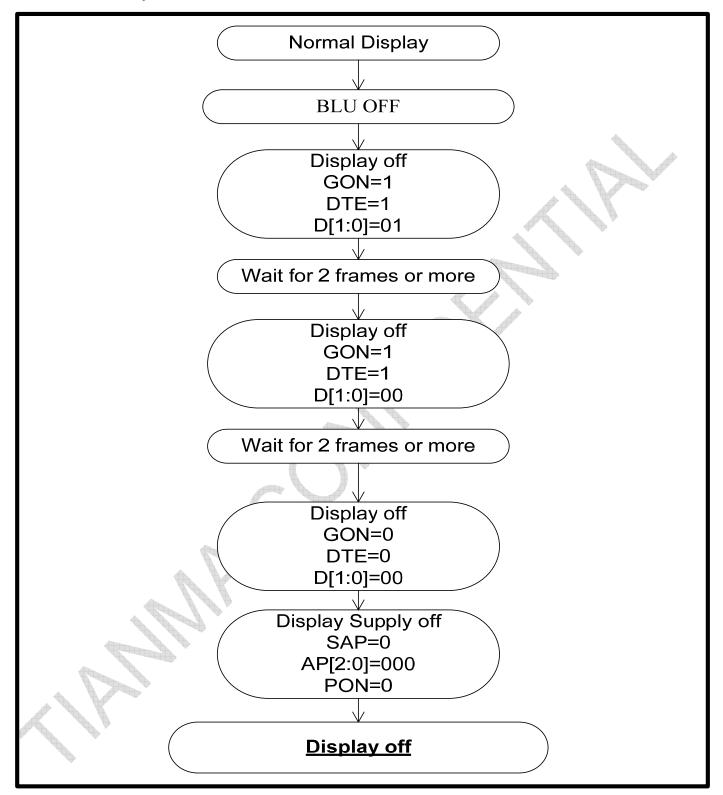
## 5.7 Power on Sequence



Page: 16 of 26



#### 5.8 Power off Sequence



Page: 17 of 26



# 6. Optical Characteristics

Item		Symbol	Condition	Min	Тур.	Max.	Unit	Remark	
View Angles		θТ	- CR≧10	60	70	-			
		θВ		60	70	-	Degree	Note 2	
View Alig	JIES	θL	CR≦ IU	60	70	-	Degree	Note 2	
		θR		50	60	-			
Contrast F	Ratio	CR	θ=0°	300	350	-	-	Note1,3	
Response	Time	Ton	<b>25</b> ℃		20	30	me	Note1,4	
Response	TITLE	Toff	250	-		30	ms	Note 1,4	
	White	х		0.250	0.300	0.350		Note1,5	
		у		0.267	0.317	0.367	_		
	RED	х		0.532	0.582	0.632			
Chromaticity		у		0.297	0.347	0.397			
Chilomaticity	GREEN	х		0.291	0.341	0.391			
	GILLIN	у		0.514	0.564	0.614			
	BLUE	x		0.097	0.147	0.197			
		У		0.045	0.095	0.145			
Uniformity		U		-	80%	-	%	Note1,6	
NTSC	NTSC		-	-	50%	-	%	Note 5	
Luminance		L	-	190	210	-	cd/m2	Note1,7	

# Test Conditions:

- 1. VDD=3.3V,  $I_L$  =20mA(Backlight current), the ambient temperature is 25  $^{\circ}$ C.
- 2. The test systems refer to Note 1 and Note 2.

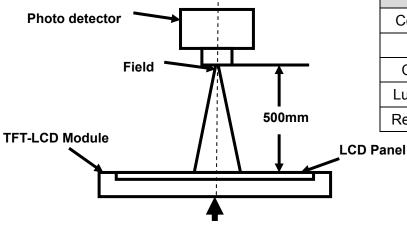
Page: 18 of 26

#### SHANGHAI TIANMA MICRO-ELECTRONICS

Note 1: Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 5 minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground

when measuring the center area of the panel.



The center of the screen

ItemPhoto DetectorFieldContrast RatioLuminanceChromaticityLum UniformityResponse TimeBM-7A2°

Note 2: Definition of viewing angle range and measurement system.

viewing angle is measured at the center point of the LCD by CONOSCOPE(ergo-80).

Note 3: Definition of contrast ratio

Contrast ratio (CR) =  $\frac{\text{Luminance measured when LCD is on the "White" state}}{\text{Luminance measured when LCD is on the "Black" state}}$ 

"White state ": The state is that the LCD should driven by Vwhite.

"Black state": The state is that the LCD should driven by Vblack.

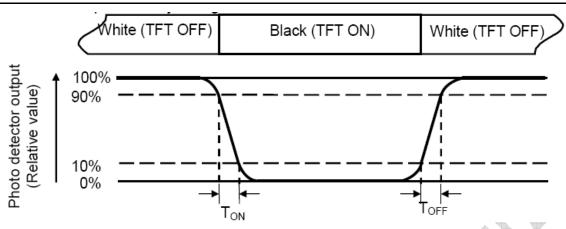
Vwhite: To be determined Vblack: To be determined.

## Note 4: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (TON) is the time between photo detector output intensity changed from 90% to 10%. And fall time (TOFF) is the time between photo detector output intensity changed from 10% to 90%.

The information contained herein is the exclusive property of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation.

Page: 19 of 26



Note 5: Definition of color chromaticity (CIE1931)

Color coordinates measured at center point of LCD.

Page: 20 of 26

# Note 6: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity(U) = Lmin/Lmax

L-----Active area length W----- Active area width

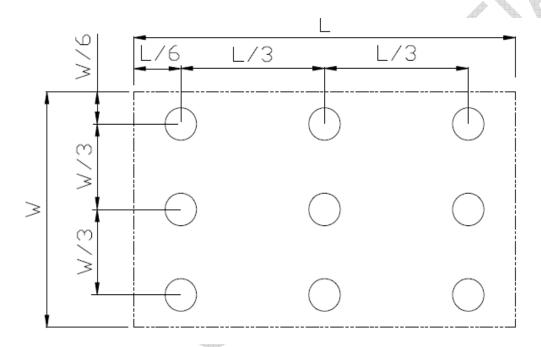


Fig. 2 Definition of uniformity

Lmax: The measured maximum luminance of all measurement position.

Lmin: The measured minimum luminance of all measurement position.

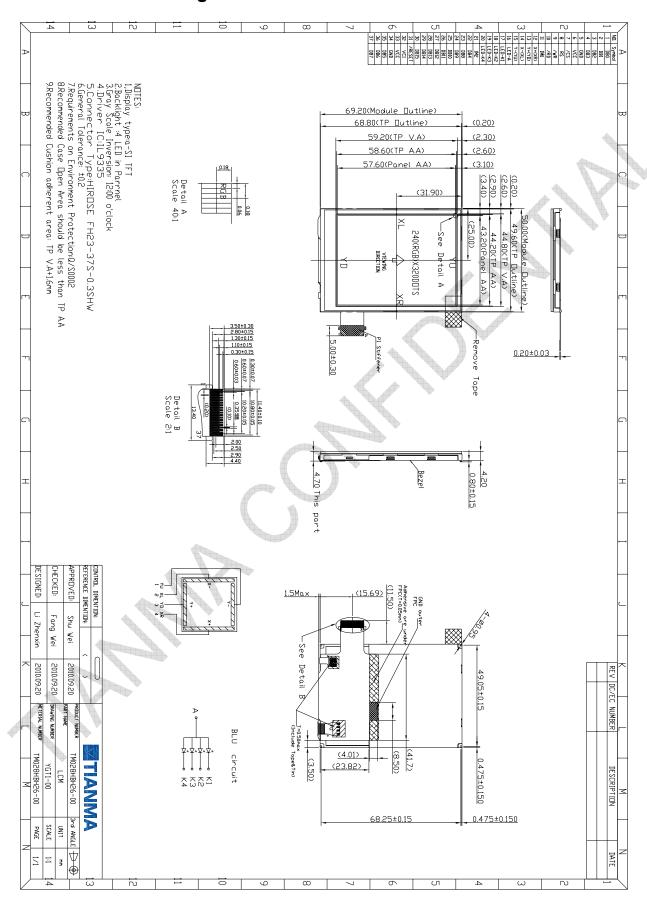
# Note 7: Definition of Luminance:

Measure the luminance of white state at center point.

Page: 21 of 26



# 7. Mechanical Drawing



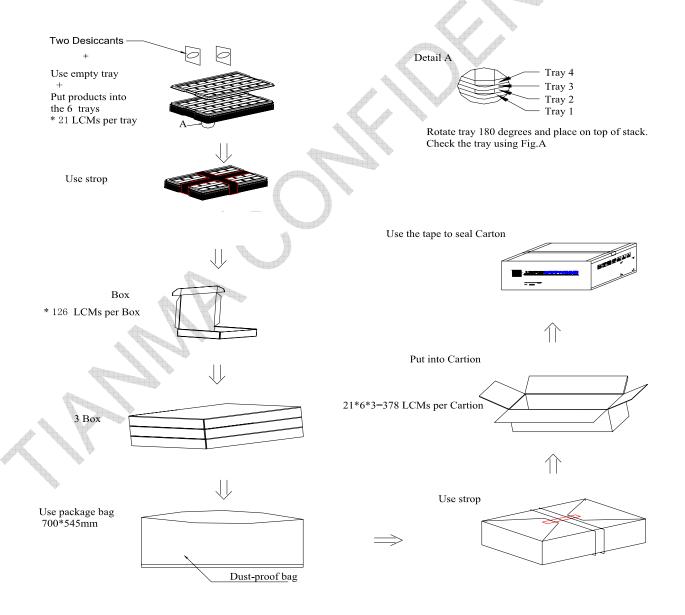
The information contained herein is the exclusive property of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation.



# **SHANGHAI TIANMA MICRO-ELECTRONICS**

#### TM028HBH26 V1.0

No	Item	Model (Material)	Dimensions(mm)	Unit Weight(Kg)	Quantity	Remark
1	LCM module	TM028HBH26	50x69.2x4.2	TBD	378	
2	Tray	PET (Transmit)	485x330x14.3	0.172	21	Anti-static
3	Anti-static bag	PE	700x545	0.046	1	
4	вох	Corrugated paper	520x345x74	0.3879	3	
5	Desiccant	Desiccant	45x50	0.002	6	
6	Carton	Corrugated paper	544x365x250	1.01	1	
7	Total weight		TBD Kg			



The information contained herein is the exclusive property of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation.

Page: 23 of 26



# 8 Environmental / Reliability Tests

No	Test Item	Condition	Remarks		
1	High Temperature Operation	Ts=+60℃, 240hrs	Note1 IEC60068-2-1,GB2423.2		
2	Low Temperature Operation	Ta=-20℃, 240hrs	IEC60068-2-1 GB2423.1		
3	High Temperature Storage	Ta=+70℃, 240hrs	IEC60068-2-1 GB2423.2		
4	Low Temperature Storage	Ta=-30℃, 240hrs	IEC60068-2-1 GB2423.1		
5	High Temperature & High Humidity Storage	Ta=+60℃, 90% RH 240 hours	Note2 IEC60068-2-78 GB/T2423.3		
6	Thermal Shock (Non-operation)	-30°C 30 min∼+70°C 30 min, Change time:5min, 20 Cycles	Start with cold temperature, End with high temperature, IEC60068-2-14,GB2423.22		
7	Electro Static Discharge (Op- eration)	C=150pF, R=330 $\Omega$ , 5points/panel Air:±8KV, 5times; Contact:±4KV, 5 times; (Environment: 15 $^{\circ}$ C $\sim$ 35 $^{\circ}$ C, 30% $\sim$ 60%, 86Kpa $\sim$ 106Kpa)	IEC61000-4-2 GB/T17626.2		
8	Vibration (Non-operation)	Frequency range:10~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z. (6 hours for total)(Package condition)	IEC60068-2-6 GB/T2423.10		
9	Shock (Non-operation)	60G 6ms, ±X,±Y,±Z 3times, for each direction	IEC60068-2-27 GB/T2423.5		
10	Package Drop Test	Height:80 cm, 1 corner, 3 edges, 6 surfaces	IEC60068-2-32 GB/T2423.8		
11	Package Vibra- tion Test	Random Vibration: 0.015GxG/Hz for 5-200Hz, -6dB/Octave from 200-500Hz 2 hours for each direction of X,Y,Z (6 hours for total)	IEC60068-2-34 GB/T2423.11		

The information contained herein is the exclusive property of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation.

Page: 24 of 26





Note1: Ts is the temperature of panel's surface.

Note2: Ta is the ambient temperature of sample.

Page: 25 of 26

# 9 Precautions for Use of LCD Modules

- 11.1 Handling Precautions
- 11.1.1. The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 11.1.2. If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 11.1.3. Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 11.1.4. The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 11.1.5. If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
- Isopropyl alcohol
- Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:— Water, Ketone, Aromatic solvents

- 11.1.6. Do not attempt to disassemble the LCD Module.
- 11.1.7. If the logic circuit power is off, do not apply the input signals.
- 11.1.8. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
- a. Be sure to ground the body when handling the LCD Modules.
- b. Tools required for assembly, such as soldering irons, must be properly ground.
- c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
- d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.
- 11.2 Storage precautions
- 11.2.1. When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 11.2.2. The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : 0°C ~ 40°C Relatively humidity: ≤80%

- 11.2.3. The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 10.3 Transportation Precautions

The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.

The information contained herein is the exclusive property of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation.

Page: 26 of 26